

1.2V Drive Pch MOSFET

EM6J1

Structure

Silicon P-channel MOSFET

● Features

- 1) Two Pch MOSFET are put in EMT6 package.
- 2) High-speed switching.
- 3) Ultra low voltage drive (1.2V drive).
- 4) Built-in G-S Protection Diode.

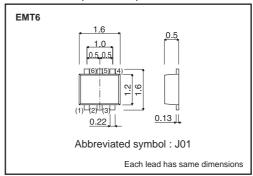
Applications

Switching

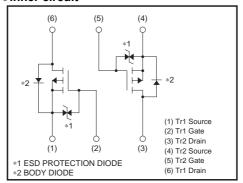
Packaging specifications

	Package	Taping
Type	Code	T2R
	Basic ordering unit (pieces)	8000
EM6J1		0

●Dimensions (Unit: mm)



•Inner circuit



●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit	
Drain-source voltage		V _{DSS}	-20	V	
Gate-source voltage		Vgss	±10	V	
Drain current	Continuous	ID	±200	mA	
	Pulsed	I _{DP} *1	±800	mA	
Source current	Continuous	Is	-100	mA	
(Body Diode)	Pulsed I _{SP} *1		-800	mA	
Total power dissipation		Pn*2	150	mW / TOTAL	
		Fυ	120	mW / ELEMENT	
Channel temperature		Tch	150	°C	
Range of storage temperature		Tstg	-55 to +150	°C	

^{*1} Pw ≦10μs, Duty cycle ≦1%

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)*	833	°C / W / TOTAL
Charline to ambient	Kiii (Cii-a)	1042	°C / W / ELEMENT

^{*} Each therminal mounted on a recommended land

^{*2} Each terminal mounted on a recommended land

EM6J1 Data Sheet

●Electrical characteristics (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	-	_	±10	μΑ	V _{GS} = ±10V, V _{DS} =0V
Drain-source breakdown voltage	$V_{(BR)\;DSS}$	-20	ı	ı	٧	I _D =-1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	_	-	-1	μΑ	Vps=-20V, Vgs=0V
Gate threshold voltage	V _{GS (th)}	-0.3	-	-1.0	V	V _{DS} =-10V, I _D =-100μA
	RDS (on)	-	0.8	1.2	Ω	I _D =-200mA, V _{GS} =-4.5V
		_	1.0	1.5	Ω	I _D =-100mA, V _{GS} =-2.5V
Static drain-source on-state resistance		_	1.3	2.2	Ω	I _D =-100mA, V _{GS} =-1.8V
resistance		_	1.6	3.5	Ω	I _D =-40mA, V _{GS} =-1.5V
		_	2.4	9.6	Ω	In=-10mA, Vgs=-1.2V
Forward transfer admittance	Y _{fs} *	0.2	_	-	S	V _{DS} =-10V, I _D =-200mA
Input capacitance	Ciss	-	115	-	pF	V _{DS} =-10V
Output capacitance	Coss	_	10	-	pF	Vgs=0V
Reverse transfer capacitance	Crss	-	6	-	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	-	6	_	ns	V _{DD} ≒–10V
Rise time	tr *	-	4	_	ns	ID=-100mA Vgs=-4.5V
Turn-off delay time	td (off) *	_	17	-	ns	VGS=-4.5V R∟≒100Ω
Fall time	t _f *	_	17	1	ns	R _G =10Ω
Total gate charge	Qg *	_	1.4	1	nC	V _{DD} ≒-10V, I _D =-200mA
Gate-source charge	Q _{gs} *	_	0.3	-	nC	V _{GS} =-4.5V
Gate-drain charge	Q _{gd} *	_	0.3	_	nC	$R_L = 50\Omega$, $R_G = 10\Omega$

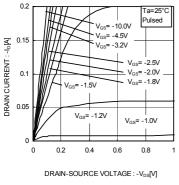
^{*}Pulsed

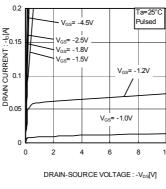
●Body diode characteristics (Source-drain)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	V _{SD} *	_	_	-1.2	V	I _S = -200mA, V _{GS} =0V

^{*}Pulsed

•Electrical characteristics curves





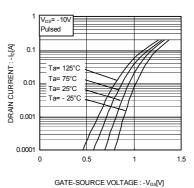
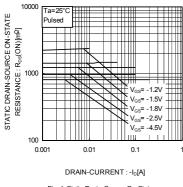
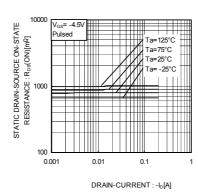


Fig.1 Typical output characteristics(I)

Fig.2 Typical output characteristics(II)

Fig.3 Typical Transfer Characteristics





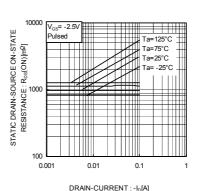


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

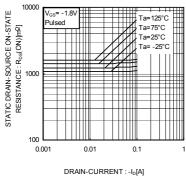


Fig.7 Static Drain-Source On-State
Resistance vs. Drain Current(IV)

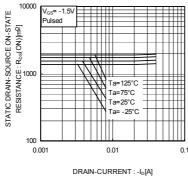


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current(V)

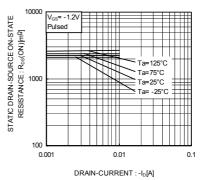
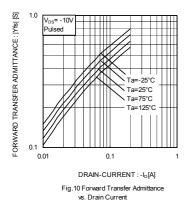
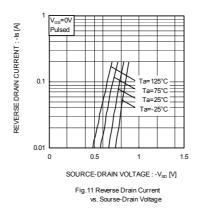
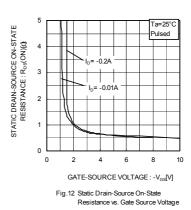
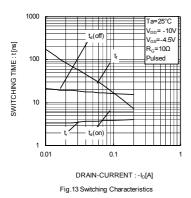


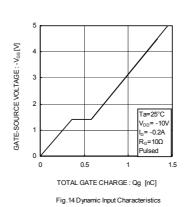
Fig.9 Static Drain-Source On-State
Resistance vs. Drain Current(VI)

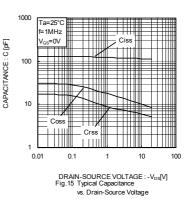












●Measurement circuit

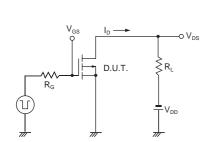


Fig.1-1 Switching Time Measurement Circuit

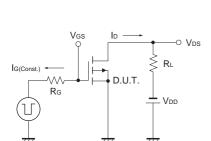


Fig.2-1 Gate Charge Measurement Circuit

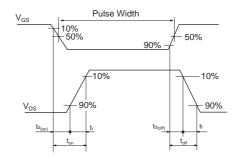


Fig.1-2 Switching Waveforms

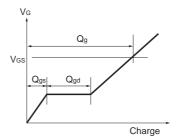


Fig.2-2 Gate Charge Waveform

● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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